Measurement condition

Ambient temperature:	23	°C
Input power level:	0	dBm
Terminating impedance:		
Input:	50	Ω
Output:	50	Ω

Characteristics

Remark:
The maximum attenuation in the pass band is defined as the insertion loss a_e. The nominal frequency f_N is fixed at 2062.5 MHz without any tolerance or limit. The values of absolute attenuation a_{abs} are guaranteed for the whole operating temperature range. The frequency shift of the filter in the operating temperature range is included in the production tolerance scheme.

D a t a		**typ. value**		**tolerance / limit**		
Insertion loss in PB	a_e	3.3	dB	max.	4.0	dB
Nominal frequency	f_N				2062.5	MHz
Passband	PB			f_N ±	37.5	MHz
Pass band variation		0.7	dB		2.0	dB
Absolute attenuation	a_{abs}					
1730 MHz … 1790 MHz		42	dB	min.	38	dB
1880 MHz … 1924 MHz		33	dB	min.	30	dB
2320 MHz … 2380 MHz		50	dB	min.	40	dB
Return loss within passband		14	dB	min.	10	dB
Input power level				max.	0	dBm
Operating temperature range	OTR			- 45 °C ... + 85°C		
Storage temperature range				- 40 °C ... + 85°C		
Temperature coefficient of frequency	TC_f *	-73	ppm/K			

*) $\Delta f(Hz) = TC_f(ppm/K) \times (T-T_0) \times f_{To}(MHz)$

Generated:

Checked / Approved:

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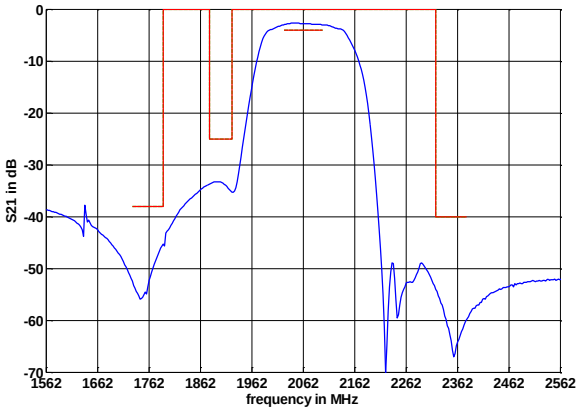
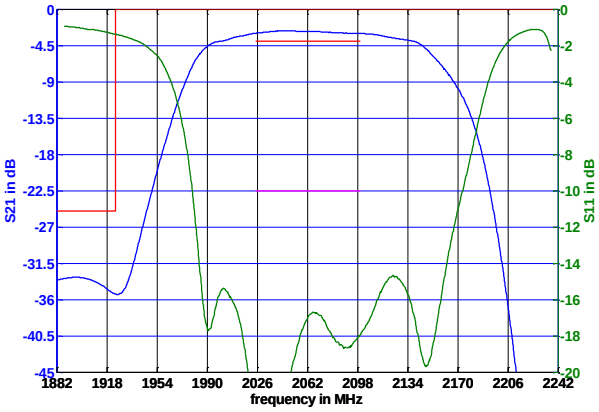
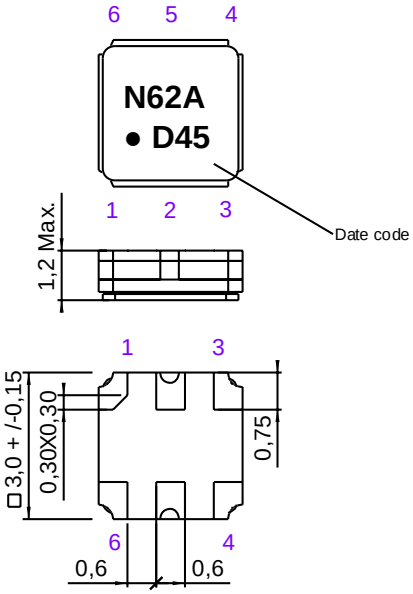
Filter characteristic





Construction and pin connection

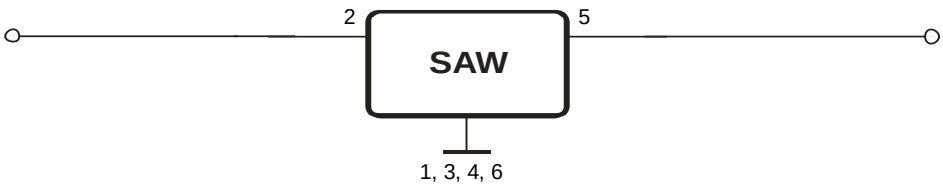
(All dimensions in mm)



1	Ground
2	Input
3	Ground
4	Ground
5	Output
6	Ground

Date code:	Year + week
D	2013
E	2014
F	2015
...	

50 Ω Test circuit



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Stability characteristics, reliability

After the following tests the filter shall meet the whole specification:

1. Shock: 500g, 1 ms, half sine wave, 3 shocks each plane;
   DIN IEC 68 T2 - 27

2. Vibration: 10 Hz to 500 Hz, 0,35 mm or 5 g respectively, 1 octave per min, 10 cycles per plane, 3 planes;
   DIN IEC 68 T2 - 6

3. Change of temperature: -55 °C to 125°C / 15 min. each / 100 cycles
   DIN IEC 68 part 2 – 14 Test N

4. Resistance to solder heat (reflow): reflow possible: three times max.;
   for temperature conditions refer to the attached "Air reflow temperature conditions" on page 4;

This filter is RoHS compliant (2011/65/EU)

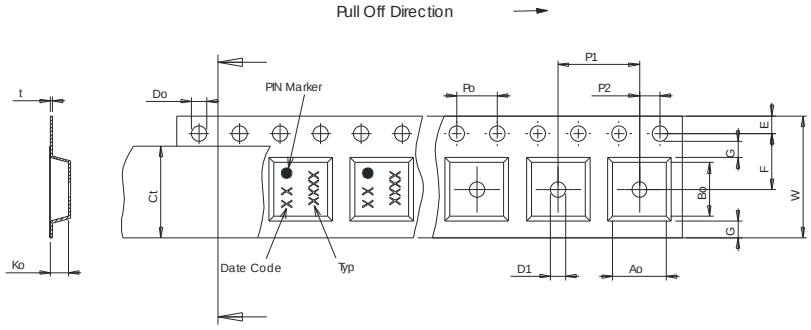
Packing

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

max. pieces of filters per reel:	3000
reel of empty components at start:	min. 300 mm
reel of empty components at start including leader:	min. 500 mm
trailer:	min. 300 mm

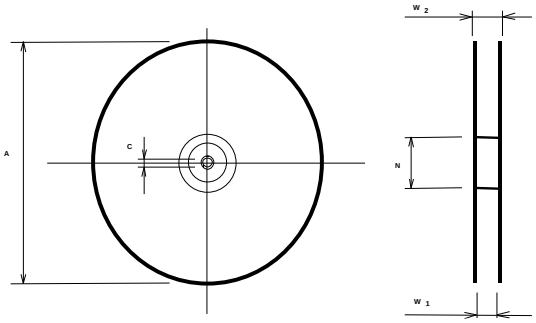
Tape (all dimensions in mm)

W	:	8,00	± 0,3
Po	:	4,00	± 0,1
Do	:	1,50	+0,1/-0
E	:	1,75	± 0,1
F	:	3,50	± 0,05
G(min)	:	0,75	
P2	:	2,00	± 0,05
P1	:	4,00	± 0,1
D1(min)	:	1,50	
Ao	:	3,25	± 0,1
Bo	:	3,25	± 0,1
Ct	:	5,3	± 0,1



Reel (all dimensions in mm)

A	:	180	
W1	:	8,4	+1,5/-0
W2(max)	:	14,4	
N(min)	:	60	
C	:	13,0	± 0,2



The minimum bending radius is 45 mm.

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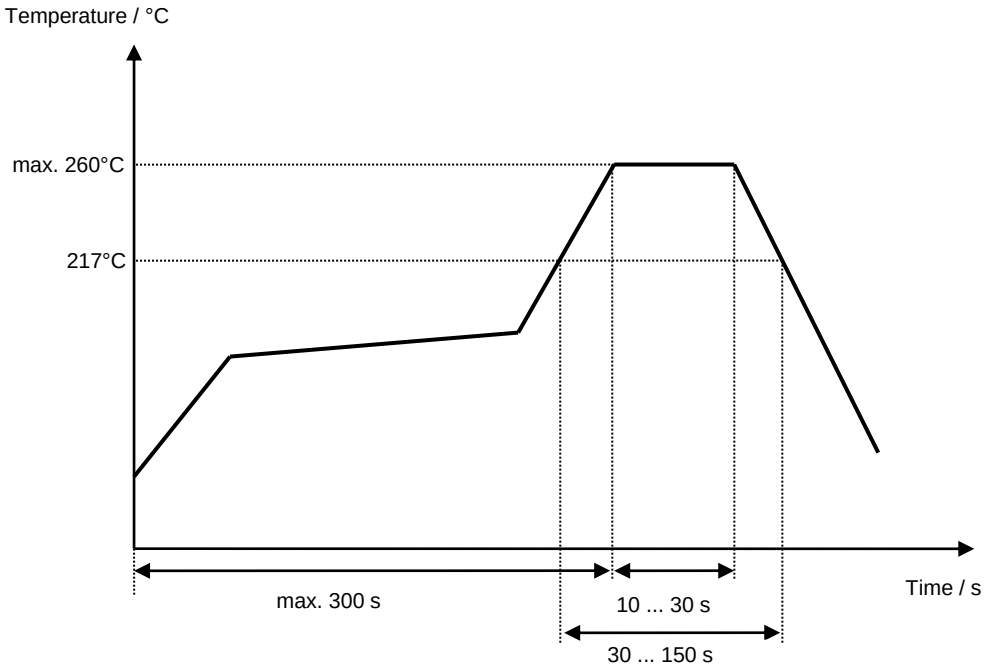
Air reflow temperature conditions

Conditions	**Exposure**
Average ramp-up rate (30°C to 217°C)	less than 3°C/second
> 100°C	between 300 and 600 seconds
> 150°C	between 240 and 500 seconds
> 217°C	between 30 and 150 seconds
Peak temperature	max. 260°C
Time within 5°C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50°C)	less than 6°C/second
Time from 30°C to Peak temperature	no greater than 300 seconds

Chip-mount air reflow profile



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History

Version	Reason of Changes	Name	Date
1.0	Generation of development specification	S.Springfeldt	08.11.2013

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